

INTERCONNECTS

SERIES 830, 831, 832, 833 • 2mm GRID HEADERS AND SOCKETS • SINGLE AND DOUBLE ROW STRIPS

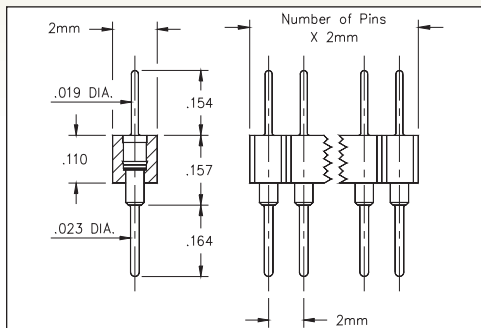


FIG. 1

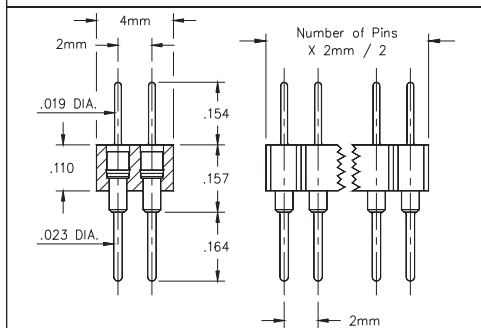


FIG. 2

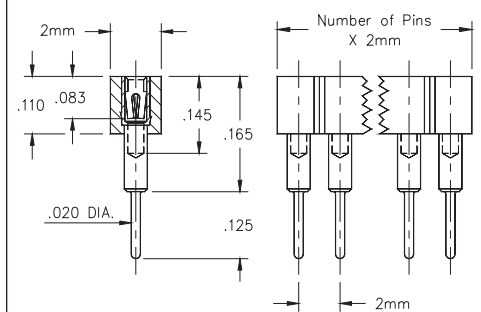


FIG. 3

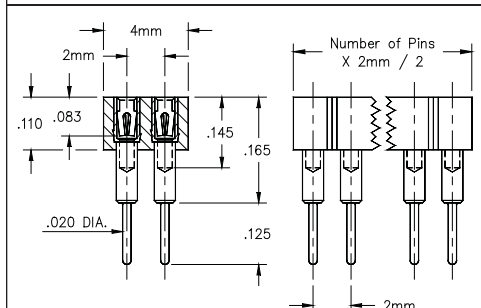


FIG. 4

- Series 830 single & double row interconnects have 2mm pin spacing and permit board stacking as low as .322"
- Pin headers (830 & 832 series) use MM #5012 pins. See page 208 for details
- Sockets (831 & 833 series) use MM #1802 receptacles and accept pin diameters from .015"-.025". See page 169 for details
- Contact is rated at 3 amps
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION

FIG. 1	Series 830...001	Single Row Pin Header
	830-XX-0-10-001000 Specify number of pins 01-50	
FIG. 2	Series 832...001	Double Row Pin Header
	832-XX-10-001000 Specify number of pins 002-100	
RoHS-2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Environmental Data, See page 264		
SPECIFY PLATING CODE XX=		
10		
90		
40		
Pin Plating		
10 μ" Au		
200 μ" Sn/Pb		
200 μ" Sn		

FIG. 3	Series 831...001		Single Row Socket			
	831-XX-0-10-001000 Specify number of pins 01-50					
FIG. 4	Series 833...001		Double Row Socket			
	833-XX-10-001000 Specify number of pins 002-100					
RoHS-2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Enviromental Data, See page 264						
SPECIFY PLATING CODE XX=						
Sleeve (Pin)			91	93	41 	43 
			200 μ" Sn/Pb	200 μ" Sn/Pb	200 μ" Sn	200 μ" Sn
Contact (Clip)			10 μ" Au	30 μ" Au	10 μ" Au	30 μ" Au

